PTL04P06

-60V/-4A P-Channel Advanced Power MOSFET

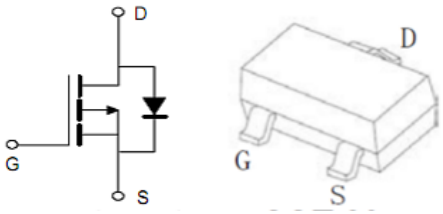
Features

- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

BVDSS	-60	V
ID	-4	A
RDSON@VGS=10V	88	mΩ
RDSON@VGS=4.5V	99	mΩ

Applications

- Low Switch
- PWM Application



SOT-23-3L

Order Information

Product	Package	Marking	Reel Size	Reel	Carton
PTL04P06	SOT-23-3L	4P06	7inch	3000PCS	180000PCS

Absolute Maximum Ratings

Symbol	Parameter		Rating	Unit
Common Ratings (TC=25°C Unless Otherwise Noted)				
$V_{(BR)DSS}$	Drain-Source Voltage		-60	V
V_{GS}	Gate-Source Voltage		±20	V
T_J	Maximum Junction Temperature		150	°C
T_{STG}	Storage Temperature Range		-55 to 150	°C
I_S	Diode Continuous Forward Current	TA =25°C	-4	A
Mounted on Large Heat Sink				
I_{DM}	Pulse Drain Current (Sillicon Limit) (Note1)	TA =25°C	-12	A
I_D	Continuous Drain current	TA =25°C	-4	A
P_D	Maximum Power Dissipation	TA =25°C	1.5	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note2)		83.3	°C/W

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Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
$V_{(BR)DSS}$	Drain- Source Breakdown Voltage	VGS=0V ID= -250μA	-60	--	--	V
I_{DSS}	Zero Gate Voltage Drain current	VDS= -60V,VGS=0V	--	--	-1	μA
I_{GSS}	Gate-Body Leakage Current	VGS=±20V,VDS=0V	--	--	±100	nA
$V_{GS(TH)}$	Gate Threshold Voltage	VDS=VGS,ID= -250μA	-1.25	-1.6	-3	V
$R_{DS(ON)}$	Drain-Source On-State Resistance (Note3)	VGS= -10V, ID= -4A	--	88	110	mΩ
		VGS= -4.5V, ID= -3A	--	99	150	mΩ
Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise stated) (Note4)						
C_{iss}	Input Capacitance	VDS= -30V, VGS=0V, F=1MHz	--	930	--	pF
C_{oss}	Output Capacitance		--	85	--	pF
C_{rss}	Reverse Transfer Capacitance		--	35	--	pF
Q_g	Total Gate Charge	VDS= -30V, ID= -4A, VGS= -10V	--	25	--	nC
Q_{gs}	Gate-Source Charge		--	3	--	nC
Q_{gd}	Gate-Drain Charge		--	7	--	nC
Switching Characteristics (Note4)						
$t_{d(on)}$	Turn-on Delay Time	VDD= -30V, RL= 7.5Ω, RG=3Ω, VGS= -10V	--	8	--	nS
t_r	Turn-on Rise Time		--	4	--	nS
$t_{d(off)}$	Turn-off Delay Time		--	32	--	nS
t_f	Turn-off Fall Time		--	7	--	nS
Source- Drain Diode Characteristics@ TJ = 25°C (unless otherwise stated)						
V_{SD}	Forward on voltage (Note3)	IS=-4A,VGS=0V	--	--	1.2	V

Note:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec
3. Pulse Test: pulse width ≤ 300 us, duty cycle ≤ 2%.
4. Guaranteed by design, not subject to production testing.

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Typical Characteristics

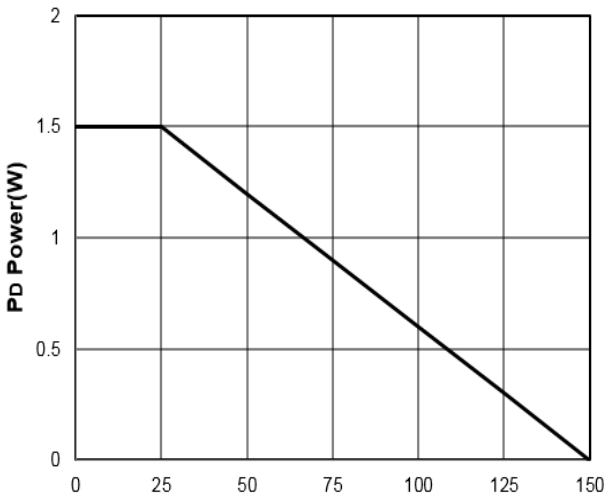

Figure1：T_J Junction Temperature（°C）

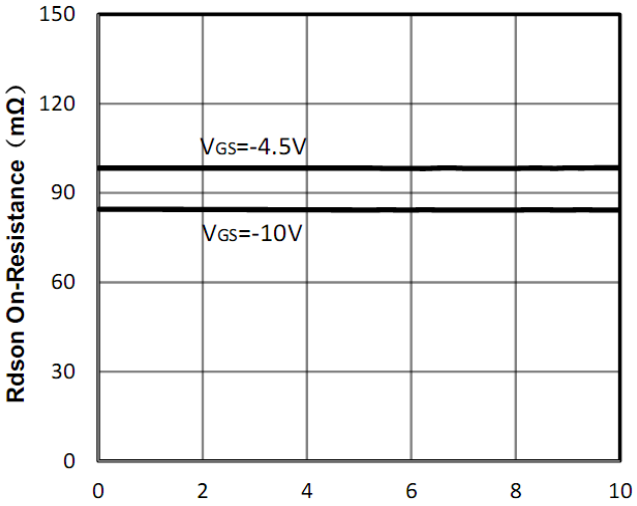

Figure2：$-I_D$ Drain Current（A）

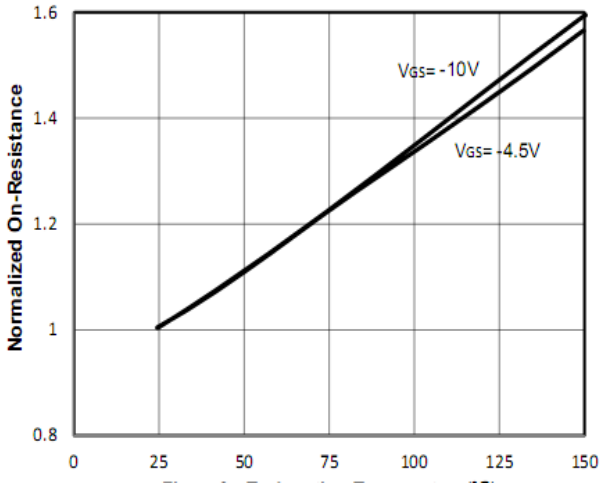

Figure3：T_J Junction Temperature（°C）

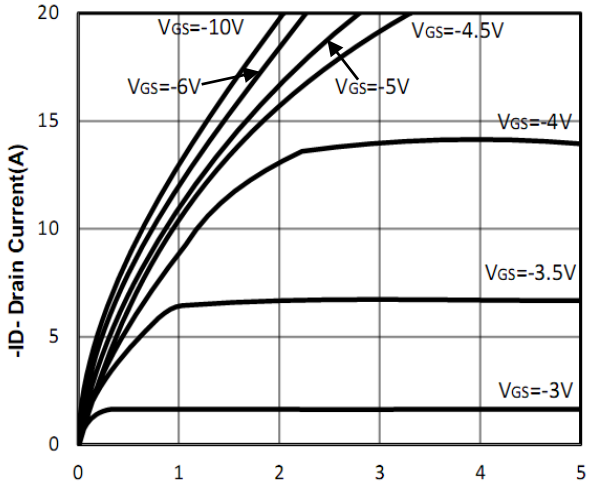

Figure4：$-V_{DS}$ Drain-Source Voltage（V）

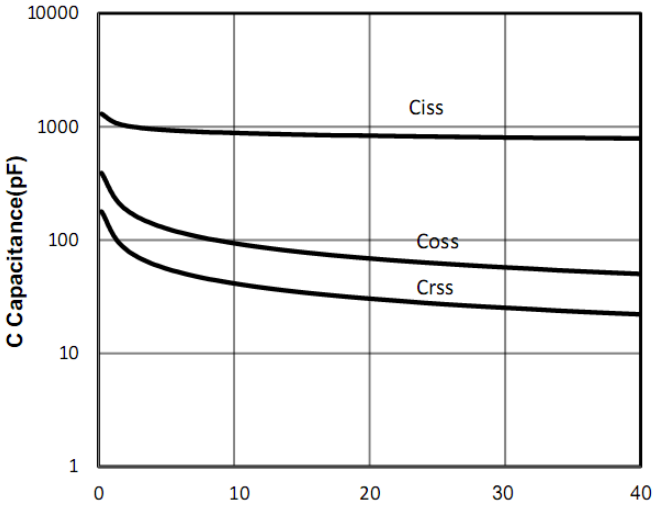

Figure5：$-V_{DS}$ Draun-Source Voltage（V）

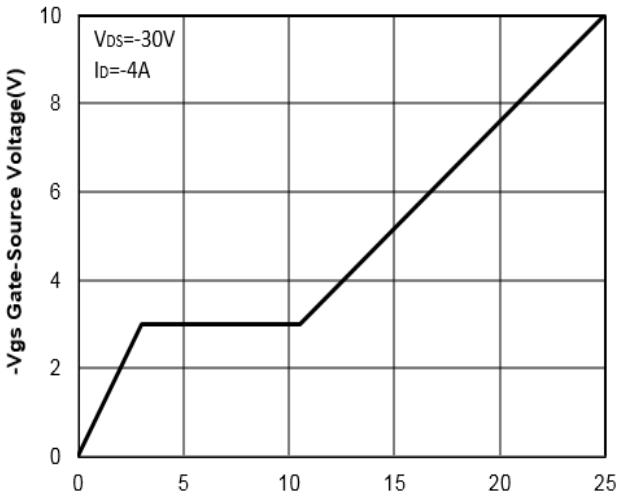

Figure6：Qg Gate Charge（nC）

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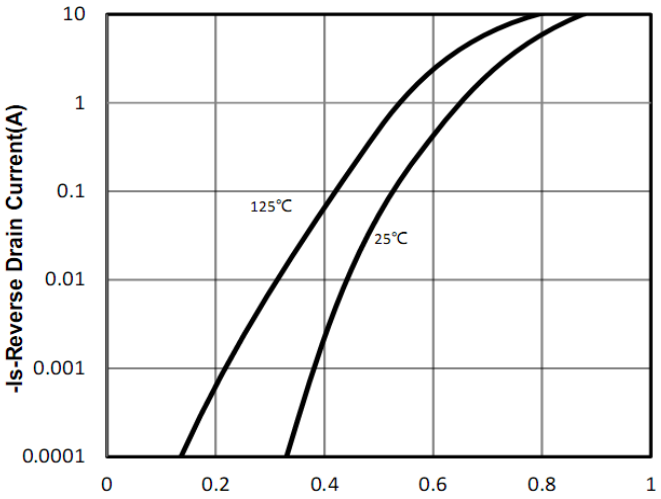

Figure7：Vsd Source-Drain Voltage（V）

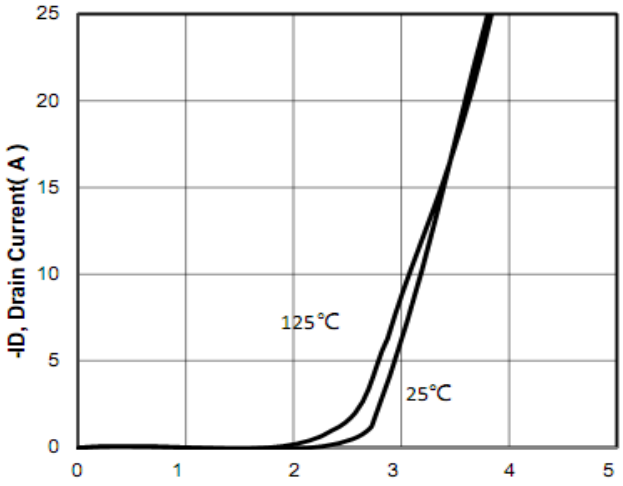

Figure8：-Vgs Gate-Source Voltage（V）

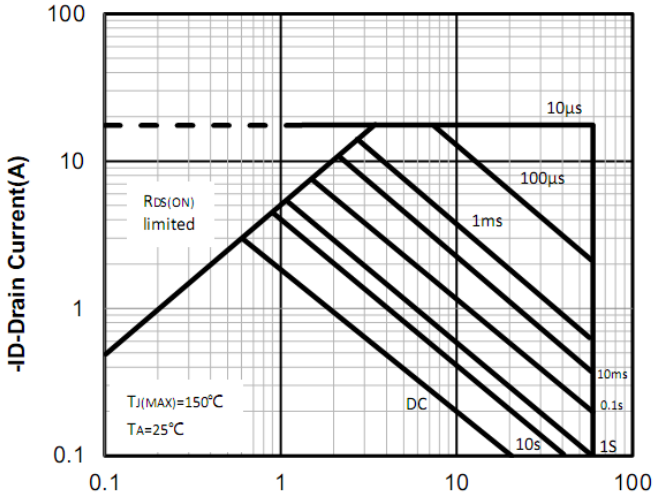

Figure9：Vds Drain -Source Voltage（V）

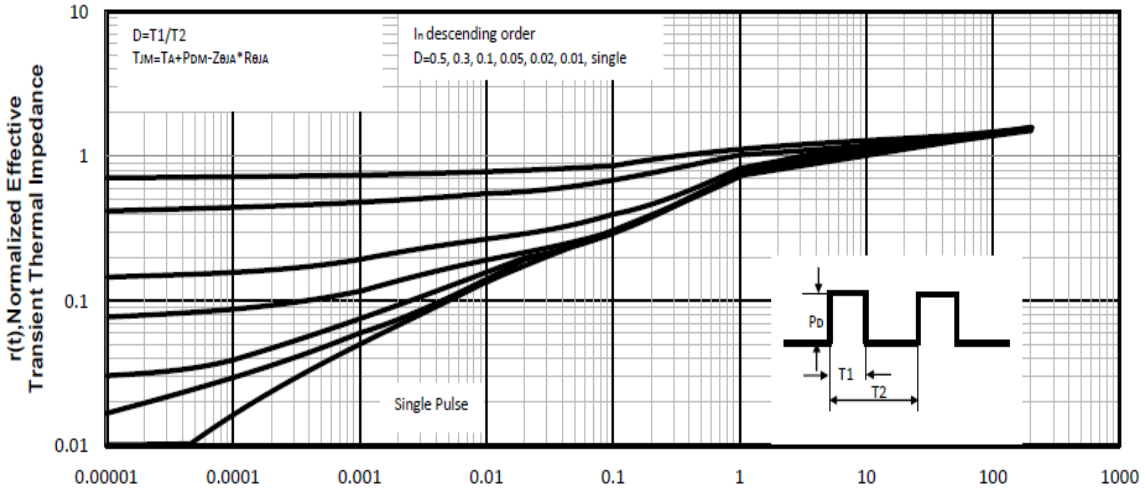

Figure10：Square Wave Pulse Duration（sec）

Test Circuit and Waveform:

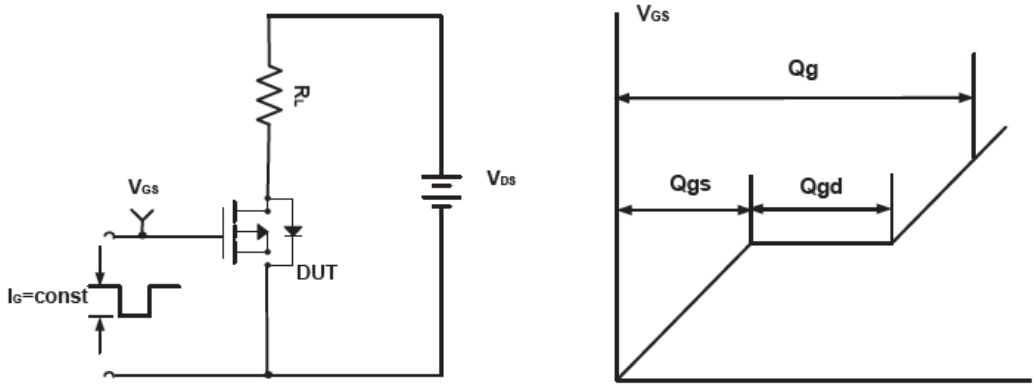

Figure A Gate Charge Test Circuit &Waveforms

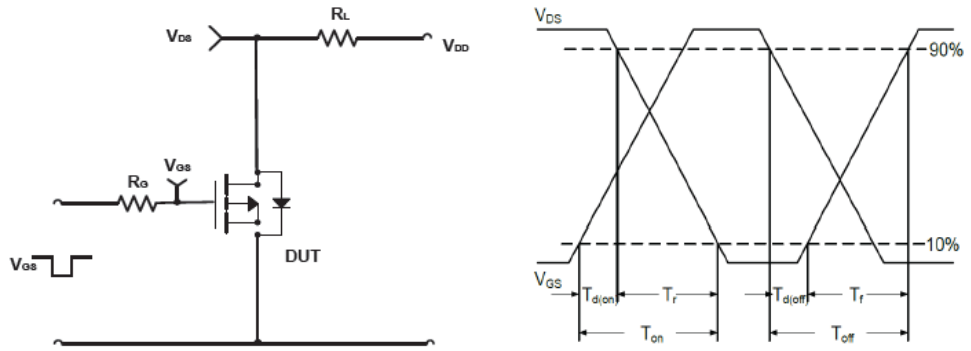

Figure B Switching Test Circuit & Waveforms

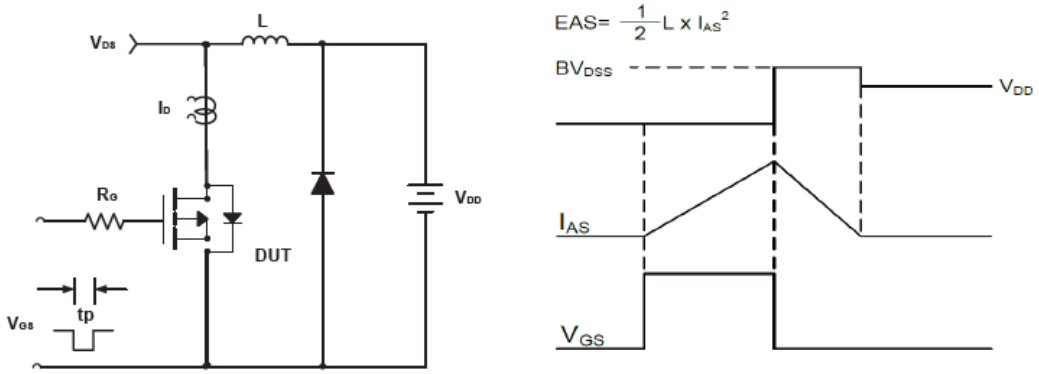

Figure C Unclamped Inductive Switching Circuit & Waveforms

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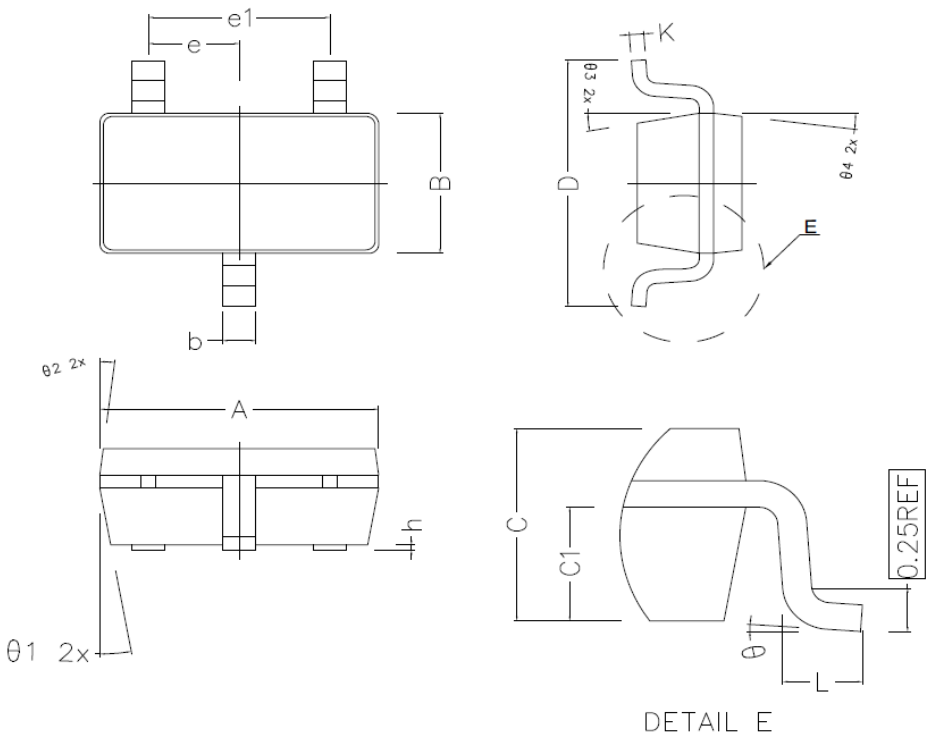
SOT-23-3L Package Outline Dimensions (Units: mm)



COMMON DIMENSIONS (UNITS OF MEASURE IS mm)			
	MIN	NORMAL	MAX
A	2.820	2.920	3.020
B	1.500	1.600	1.700
C	1.050	1.100	1.150
C1	0.600	0.650	0.700
D	2.650	2.800	2.950
L	0.300	0.450	0.600
b	0.280	0.350	0.420
h	0.020	0.050	0.100
K	0.120	—	0.230
e	0.950TYPE		
e1	1.900TYPE		
θ_1	10° TYPE		
θ_2	7° TYPE		
θ_3	10° TYPE		
θ_4	7° TYPE		
θ	0° ~ 8°		